

PATENT

Case Docket No. MICRON.240A

Date: August 12, 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s) : Ammar Derraa et al.
Appl. No. : 09/944,903
Filed : August 30, 2001
For : HIGH ASPECT RATIO
CONTACT STRUCTURE WITH
REDUCED SILICON
CONSUMPTION
Group Art Unit : 2826
Class/Sub-Class : 257-384000
Examiner : Victor A. Mandala

I hereby certify that this correspondence and all marked attachments are being deposited with the United States Postal Service as first class mail in an envelope addressed to: Mail Stop Issue Fee, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on

August 13, 2004

(Date)

Linda H. Liu, Reg. No. 51,240

TRANSMITTAL LETTER

MAIL STOP ISSUE FEE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Enclosed for filing is the Issue Fee for the above-identified application:


- (X) Form PTOL-85.
- (X) A check in the amount of \$1,660 to cover the issue fee, publication fee, and advanced order of copies is enclosed.
- (X) Six sheet(s) of drawings.
- (X) The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment, to Account No. 11-1410.

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(X) Return prepaid postcard.



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